

a1 wherein the first laser beam is a third harmonic of a first YAG laser, and

wherein the second laser beam is a second harmonic of a second YAG laser.

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3 (Amended). A method of manufacturing a semiconductor device, comprising:

forming an amorphous semiconductor film over a substrate;

irradiating the amorphous semiconductor film with a first laser beam to form a first crystalline semiconductor film; and

irradiating the first crystalline semiconductor film with a second laser beam to form a second crystalline semiconductor film,

Q2 wherein the first laser beam is a YVO<sub>4</sub> laser, and

wherein the second laser beam is a YAG laser.

4 (Amended). A method of manufacturing a semiconductor device, comprising:

forming an amorphous semiconductor film over a substrate;

irradiating the amorphous semiconductor film with a first laser beam to form a first crystalline semiconductor film; and

irradiating the first crystalline semiconductor film with a second laser beam to form a second crystalline semiconductor film, wherein

the second laser beam is 370 to 650 nm in wavelength, and

wherein the first laser beam is a YVO<sub>4</sub> laser.

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6 (Amended). A method according to claim 1, wherein the semiconductor device is

Q3 incorporated into a device selected from the group consisting of a liquid crystal display device and a light emitting device.

7 (Amended). A method according to claim 1, wherein the semiconductor device is incorporated into a device selected from the group consisting of a cellular phone, a video camera, a digital camera, a projector, a goggle type display, a personal computer, a DVD player, an electronic book, and a portable information terminal.

8 (Amended). A method according to claim 3, wherein the semiconductor device is incorporated into a device selected from the group consisting of a liquid crystal display device and a light emitting device.

a<sup>3</sup> 9 (Amended). A method according to claim 3, wherein the semiconductor device is incorporated into a device selected from the group consisting of a cellular phone, a video camera, a digital camera, a projector, a goggle type display, a personal computer, a DVD player, an electronic book, and a portable information terminal.

10 (Amended). A method according to claim 4, wherein the semiconductor device is incorporated into a device selected from the group consisting of a liquid crystal display device and a light emitting device.

11 (Amended). A method according to claim 4, wherein the semiconductor device is incorporated into a device selected from the group consisting of a cellular phone, a video camera, a digital camera, a projector, a goggle type display, a personal computer, a DVD player, an electronic book, and a portable information terminal.

12 (Amended). A method according to claim 5, wherein the semiconductor device is incorporated into a device selected from the group consisting of a liquid crystal display device and a light emitting device.

23 13 (Amended). A method according to claim 5, wherein the semiconductor device is incorporated into a device selected from the group consisting of a cellular phone, a video camera, a digital camera, a projector, a goggle type display, a personal computer, a DVD player, an electronic book, and a portable information terminal.

#### REMARKS

Applicant will address each of the Examiner's objections and rejections in the order in which they appear in the Office Action of March 28, 2002.

#### Claim Rejections - 35 USC §112

The Examiner rejects Claims 6-13 under 35 USC §112, second paragraph, as being indefinite. In particular, the Examiner states that in each of these claims, "...it is not clear how a semiconductor device can be an electronic device, such as, for example, a cellular phone."

Applicant has now amended each of these claims to recite that the semiconductor device is "incorporated into a device selected from the group consisting of" electronic devices, such as a cellular phone. Applicant is amending the claims not to narrow them but instead to clarify the meaning therein. It is respectfully submitted that this overcomes the Examiner's objection, and it is requested that this rejection now be withdrawn.